Product data sheet

1. General description

P-channel enhancement mode Field-Effect Transistor (FET) in an MLPAK33 (SOT8002) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

2. Features and benefits

- Low threshold voltage
- Trench MOSFET technology
- MLPAK33 package (3.3 x 3.3 mm footprint)

3. Applications

- · High-side load switch
- · Battery management
- · DC-to-DC conversion
- Switching circuits

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V_{DS}	drain-source voltage	T _j = 25 °C		-	-	-20	V
V_{GS}	gate-source voltage			-12	-	12	V
I _D	drain current	V _{GS} = -4.5 V; T _{amb} = 25 °C; t ≤ 5 s	[1]	-	-	-17.2	Α
Static charact	Static characteristics						
R _{DSon}	drain-source on-state	$V_{GS} = -4.5 \text{ V}; I_D = -10.5 \text{ A}; T_j = 25 ^{\circ}\text{C}$		-	9.1	11.4	mΩ
	resistance	V_{GS} = -2.5 V; I_D = -8 A; T_j = 25 °C		-	14.8	19.7	mΩ

^[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm².



5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S	source	1 2 3 4	D I
2	S	source		
3	S	source		G TENT
4	G	gate	l h d	s
5	D	drain		017aaa257
6	D	drain		
7	D	drain	MLPAK33 (SOT8002-1)	
8	D	drain		

6. Ordering information

Table 3. Ordering information

Type number	Package							
	Name	Description	Version					
PXP011-20QX		plastic thermal enhanced surface mounted package; mini leads; 8 terminals; pitch 0.65 mm; 3.3 x 3.3 x 0.8 mm body	SOT8002-1					

7. Marking

Table 4. Marking codes

Type number	Marking code
PXP011-20QX	9AV

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{DS}	drain-source voltage	T _j = 25 °C		-	-20	V
V _{GS}	gate-source voltage			-12	12	V
I _D	drain current	V _{GS} = -4.5 V; T _{amb} = 25 °C; t ≤ 5 s	[1]	-	-17.2	Α
		V _{GS} = -4.5 V; T _{amb} = 25 °C	[1]	-	-10.5	Α
		V _{GS} = -4.5 V; T _{amb} = 100 °C	[1]	-	-6.6	Α
		V _{GS} = -4.5 V; T _{sp} = 25 °C		-	-56.6	Α
I _{DM}	peak drain current	T_{amb} = 25 °C; single pulse; $t_p \le 10 \mu s$		-	-93	Α
P _{tot}	total power dissipation	T _{amb} = 25 °C; t ≤ 5 s	[1]	-	4.8	W
		T _{amb} = 25 °C	[1]	-	1.8	W
		T _{sp} = 25 °C		-	50	W
Tj	junction temperature			-55	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C
Source-drai	n diode		•			
Is	source current	T _{amb} = 25 °C	[1]	-	-1.7	Α

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm².

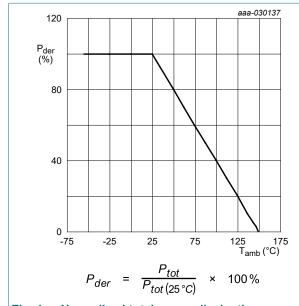


Fig. 1. Normalized total power dissipation as a function of ambient temperature

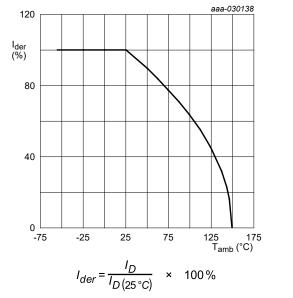


Fig. 2. Normalized continous drain current as a function of ambient temperature

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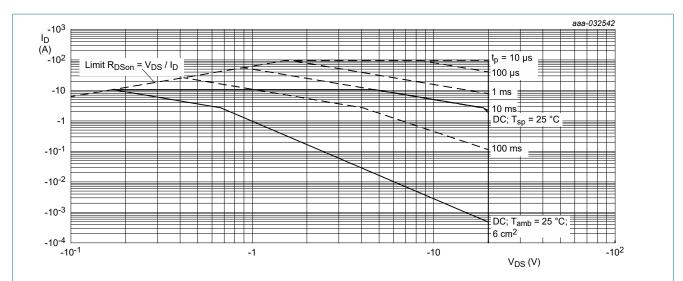


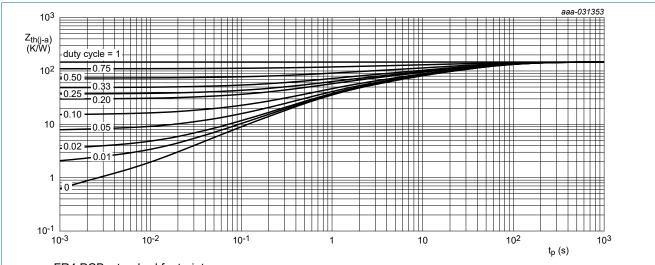
Fig. 3. Safe operating area; junction to ambient; continuous and peak drain currents as a function of drain-source voltage

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)} thermal resistance from junction to ambient	in free air [1	[1]	-	145	185	K/W	
	junction to ambient		[2]	-	55	70	K/W
		in free air; t ≤ 5 s	[2]	-	21	26	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point			-	1.5	2.5	K/W

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 6 cm².



FR4 PCB, standard footprint

Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

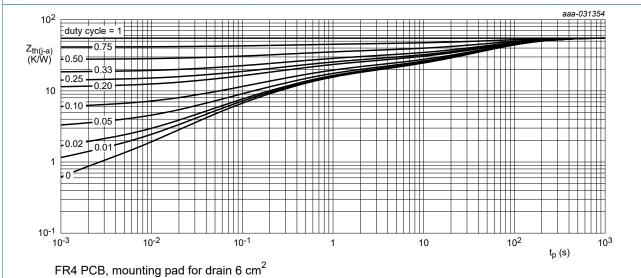


Fig. 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	cteristics					
V _{(BR)DSS}	drain-source breakdown voltage	I_D = -250 μ A; V_{GS} = 0 V; T_j = 25 °C	-20	-	-	V
V_{GSth}	gate-source threshold voltage	$I_D = -250 \mu A; V_{DS} = V_{GS}; T_j = 25 \text{ °C}$	-0.7	-0.9	-1.25	V
I _{DSS}	drain leakage current	V _{DS} = -20 V; V _{GS} = 0 V; T _j = 25 °C	-	-	-1	μA
I _{GSS}	gate leakage current	V _{GS} = -12 V; V _{DS} = 0 V; T _j = 25 °C	-	-	-0.1	μA
		V _{GS} = 12 V; V _{DS} = 0 V; T _j = 25 °C	-	-	0.1	μA
R _{DSon}	drain-source on-state	$V_{GS} = -4.5 \text{ V}; I_D = -10.5 \text{ A}; T_j = 25 \text{ °C}$	-	9.1	11.4	mΩ
, DSON	resistance	$V_{GS} = -4.5 \text{ V}; I_D = -10.5 \text{ A}; T_j = 150 ^{\circ}\text{C}$	-	12.9	16.2	mΩ
		$V_{GS} = -2.5 \text{ V}; I_D = -8 \text{ A}; T_j = 25 \text{ °C}$	-	14.8	19.7	mΩ
g _{fs}	forward transconductance	V_{DS} = -10 V; I_D = -10.5 A; T_j = 25 °C	-	52	-	S
R _G	gate resistance	f = 1 MHz	-	2.3	-	Ω
Dynamic ch	aracteristics		ı			
Q _{G(tot)}	total gate charge	V _{DS} = -10 V; I _D = -10.5 A; V _{GS} = -4.5 V;	-	43.4	65.1	nC
Q _{GS}	gate-source charge	T _j = 25 °C	-	6.9	-	nC
Q _{GS(th)}	pre-threshold gate- source charge		-	3.7	-	nC
Q _{GS(th-pl)}	post-threshold gate- source charge		-	3.2	-	nC
Q _{GD}	gate-drain charge		-	14.2	-	nC
V_{GSpl}	gate-source plateau voltage	V_{DS} = -10 V; I_D = -10.5 A; T_j = 25 °C	-	-1.7	-	V
C _{iss}	input capacitance	V _{DS} = -10 V; f = 1 MHz; V _{GS} = 0 V;	-	4200	-	pF
C _{oss}	output capacitance	T _j = 25 °C	-	630	-	pF
C _{rss}	reverse transfer capacitance		-	580	-	pF
t _{d(on)}	turn-on delay time	$V_{DS} = -10 \text{ V}; I_D = -8 \text{ A}; V_{GS} = -4.5 \text{ V};$	-	11	-	ns
t _r	rise time	$R_{G(ext)} = 5 \Omega; T_j = 25 ^{\circ}C$	-	33	-	ns
t _{d(off)}	turn-off delay time	1	-	69	-	ns
t _f	fall time		-	44	-	ns
Source-drai	n diode		'	'		
V _{SD}	source-drain voltage	$I_S = -1.7 \text{ A}; V_{GS} = 0 \text{ V}; T_j = 25 ^{\circ}\text{C}$	-	-0.7	-1.2	V
t _{rr}	reverse recovery time	I _S = -1.7 A; dI _S /dt = 100 A/μs;	-	28	-	ns
Q _r	recovered charge	$V_{GS} = -4.5 \text{ V}; V_{DS} = -10 \text{ V}; T_j = 25 \text{ °C}$	-	17	-	nC
t _a	reverse recovery rise time		-	13	-	ns
t _b	reverse recovery fall time	1	-	15	-	ns

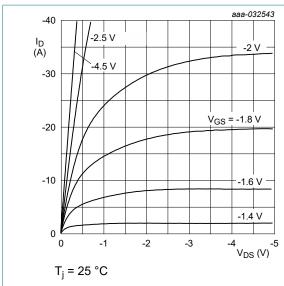


Fig. 6. Output characteristics: drain current as a function of drain-source voltage; typical values

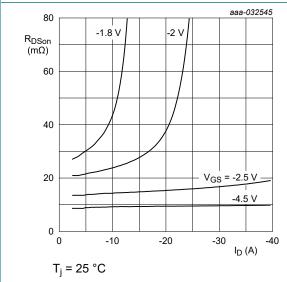


Fig. 8. Drain-source on-state resistance as a function of drain current; typical values

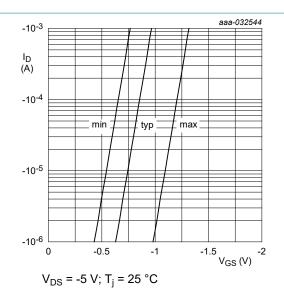


Fig. 7. Sub-threshold drain current as a function of gate-source voltage

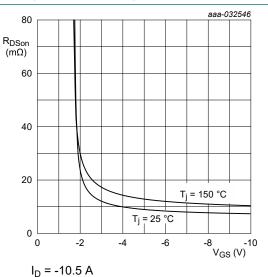


Fig. 9. Drain-source on-state resistance as a function of gate-source voltage; typical values

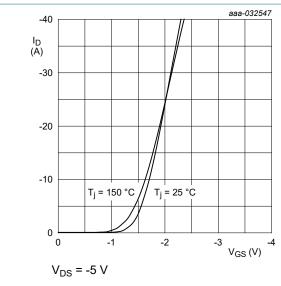


Fig. 10. Transfer characteristics: drain current as a function of gate-source voltage; typical values

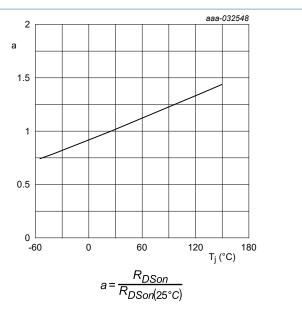


Fig. 11. Normalized drain-source on-state resistance as a function of junction temperature; typical values

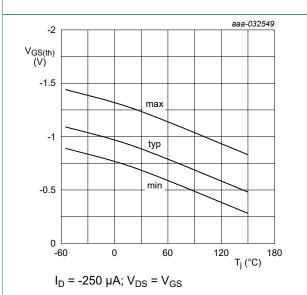
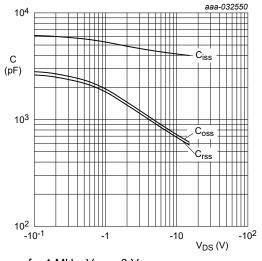


Fig. 12. Gate-source threshold voltage as a function of junction temperature



 $f = 1 MHz; V_{GS} = 0 V$

Fig. 13. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

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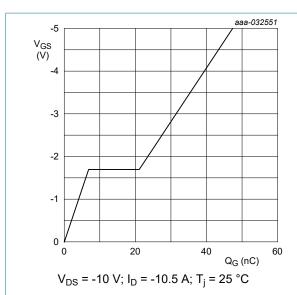


Fig. 14. Gate-source voltage as a function of gate charge; typical values

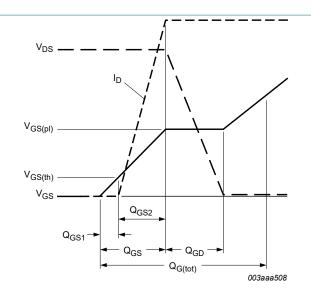


Fig. 15. Gate charge waveform definitions

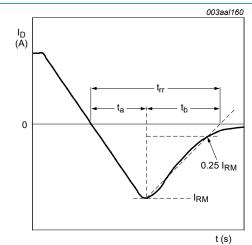


Fig. 16. Reverse recovery timing definition

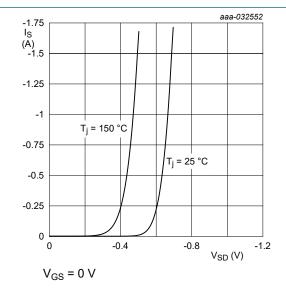
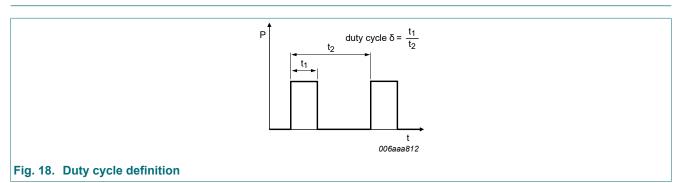


Fig. 17. Source current as a function of source-drain voltage; typical values

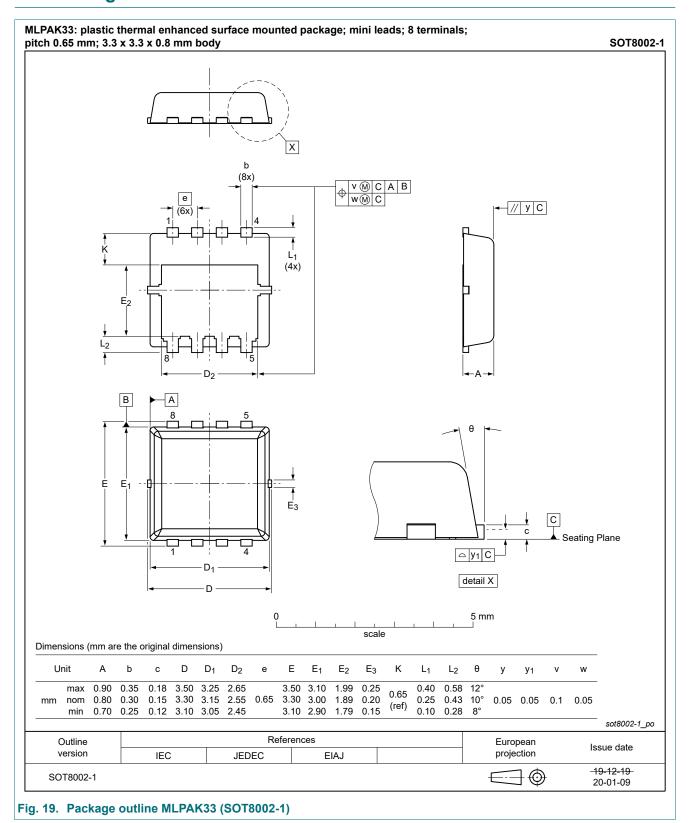
11. Test information



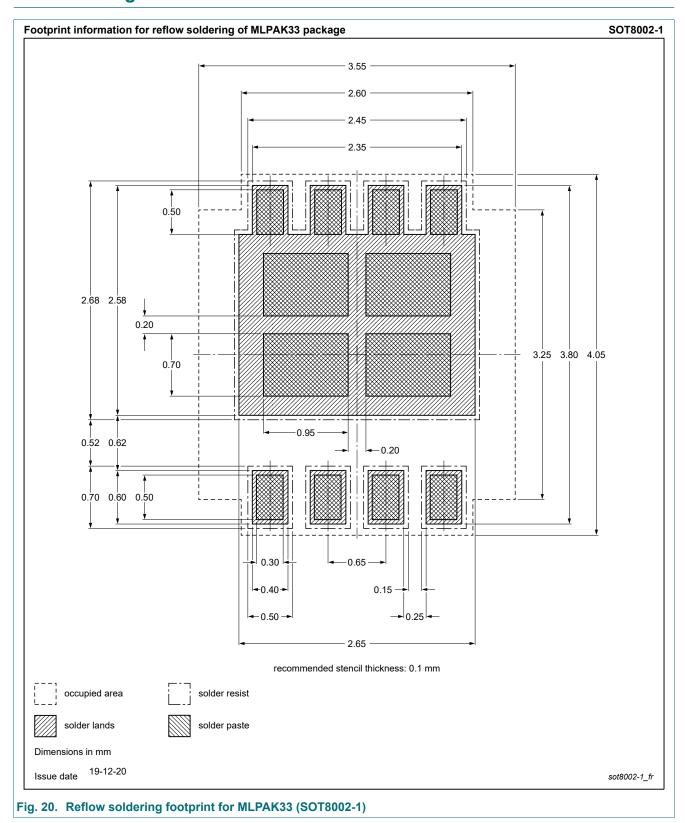
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Product data sheet

12. Package outline



13. Soldering



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14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PXP011-20QX v.1	20210105	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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